



FEATURES

- OUTPUT CURRENT UP TO 16A
- SMALL SIZE AND LOW PROFILE :
1.30" X 0.53" X 0.30" (SMD) ; 2.00" X 0.50" X 0.28" (SIP)
- HIGH EFFICIENCY - 92% @ 3.3V FULL LOAD
- INPUT RANGE FROM 8.3VDC TO 14.0VDC
- FIXED SWITCHING FREQUENCY (300KHZ)
- SMD & SIP PACKAGES
- OUTPUT VOLTAGE PROGRAMMABLE FROM 0.75VDC TO 5.0VDC VIA EXTERNAL RESISTOR
- INPUT UNDER-VOLTAGE LOCKOUT
- UL60950-1, EN60950-1 AND IEC60950-1 LICENSED
- ISO9001 CERTIFIED MANUFACTURING FACILITIES
- COMPLIANT TO RoHS EU DIRECTIVE 2002/95/EC

APPLICATIONS

Wireless Network
Telecom/Datacom
Industry Control System
Distributed Power Architectures
Semiconductor Equipment
Microprocessor Power Applications

OPTIONS

Positive Logic Remote on/off

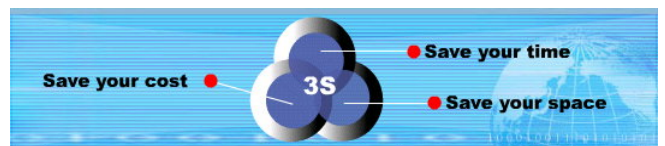
DESCRIPTION

DOS16-12T (SMD type), DOH16-12T (for Vertical Mounting SIP type) and DOH16-12TA (for Horizontal Mounting SIP type) are non-isolated DC/DC converters that can deliver up to 16A of output current with full load efficiency of 92% at 3.3V output.

TECHNICAL SPECIFICATION All specifications are typical at nominal input, full load and 25°C otherwise noted

OUTPUT SPECIFICATIONS		
Output current		16A max.
Voltage accuracy	Full load and Vin(nom.)	± 2%Vo(set)
Minimum load		0%
Line regulation	Vin=Vin(min.) to Vin(max.) at Full Load	± 0.3%Vo(set),typ.
Load regulation	No Load to Full Load	± 0.4%Vo(set),typ.
Ripple and noise (Note2)	20MHz bandwidth	30mVrms,max. 75mVp-p,max.
Temperature coefficient		±0.4%, typ.
Dynamic load response (Note 2)	ΔIo / Δt = 2.5A/μS, Vin(nom.)	Peak deviation 200mV,typ.
	Load change step (50% to 100% or 100% to 50% of Io(max.))	Setting time (Vo<10%peak deviation) 25μS,typ.
Dynamic load response (Note 3)	ΔIo / Δt = 2.5A/μS, Vin(nom.)	Peak deviation 100mV,typ.
	Load change step (50% to 100% or 100% to 50% of Io(max.))	Setting time (Vo<10%peak deviation) 50μS,typ.
Output current limit		180%
Output short-circuit current		Hiccup, automatics recovery
External load capacitance	ESR ≥ 1mΩ	1000μF,max.
	ESR ≥ 10mΩ	5000μF,max.
Output voltage overshoot-startup	Vin=Vin(min.) to Vin(max) F.L.	1%Vo(set)
Voltage adjustability (see fig.1)	(Note 4)	0.7525V ~ 5.0V
GENERAL SPECIFICATIONS		
Efficiency		See table
Isolation voltage		None
Switching frequency		300KHz, typ.
Approvals and standard		IEC60950-1, UL60950-1, EN60950-1
Dimensions	SMD	1.30 X 0.53 X 0.30 Inch (33.0 X 13.5 X 7.7 mm)
	SIP	2.00 X 0.50 X 0.28 Inch (50.8 X 12.7 X 7.2 mm)
Weight		6.0g(0.22oz)
MTBF (Note 1)	BELLCORE TR-NWT-000332	1.409 x 10 ⁷ hrs
	MIL-HDBK-217F	6.704 x 10 ⁵ hrs

INPUT SPECIFICATIONS		
Input voltage range	Vo(set) ≤ 3.63V	Vin(nom.) = 12V 8.3 – 14VDC
	Vo(set) > 3.63V	8.3 – 13.2VDC
Maximum input current	Vin=8.3 to 14.0Vdc; Io=Io(max.)	10A
Input filter (Note 5)		C filter
Input no load current (Vin=12V, Io=0, module enabled)	Vo(set) = 0.75Vdc	40mA,typ.
	Vo(set) = 5.0Vdc	100mA,typ.
Input under voltage lockout	Start-up voltage	7.9V,typ.
	Shutdown voltage	7.8V,typ.
Input reflected ripple current	5~20MHz, 1μH source impedance	30mA p-p
ENVIRONMENTAL SPECIFICATIONS		
Operating ambient temperature		-40°C ~ +85°C(with derating)
Storage temperature range		-55°C ~ +125°C
Thermal shock		MIL-STD-810F
Over temperature protection		125°C,typ
FEATURE SPECIFICATIONS		
Remote ON/OFF(Note 6)		
Negative logic(standard)	ON = 0V < Vr < 0.3V	IIN=10μA,max
	OFF = 2.5V < Vr < Vin(max)	IIN=1mA,max
Positive logic(option)	ON = (Vin-4) < Vr < Vin(max)	IIN=10μA,max
	OFF=0V < Vr < 0.3V	IIN=1mA,max
Input current of Remote control pin		10μA~1.0mA
Remote off state input current	Nominal Vin	2.0mA,typ
Remote sense range		0.5V,max.
Rise time	Time for Vo to rise from 10% to 90%of Vo(set)	6ms,max.
Turn-on delay time	Case 1 (Note 7)	3ms,typ.
	Case 2 (Note 8)	3ms,typ.





Model Name	ON/OFF Logic	Package	Input Voltage	Output Voltage	Output Current		Efficiency (%) 12Vin, 3.3Vdc@16A
					Min. Load	Max. Load	
DOS16-12T	Negative	SMD	Vo(set) ≤ 3.63V Vin = 8.3-14Vdc	0.75 ~ 5.0Vdc	0A	16A	92%
DOS16-12T-P	Positive						
DOH16-12T	Negative	Vertical Mounting SIP	Vo(set) > 3.63V Vin = 8.3-13.2Vdc	0.75 ~ 5.0Vdc	0A	16A	92%
DOH16-12T-P	Positive						
DOH16-12TA	Negative	Horizontal Mounting SIP	Vo(set) > 3.63V Vin = 8.3-13.2Vdc	0.75 ~ 5.0Vdc	0A	16A	92%
DOH16-12TA-P	Positive						

Note

- BELLCORE TR-NWT-000332. Case 1: 50% Stress, Temperature at 40°C. MIL-HDBK-217F Notice2 @Ta=25 °C, Full load(Ground, Benign, controlled environment).
- External with C_{out} = 1µF ceramic//10µF tantalum capacitors.
- External with C_{out} = 2x150µF polymer capacitors.
- Output voltage programmable from 0.7525V to 5V by connecting a single resistor (shown as R_{trim} in Table 1) between the TRIM and GND pins of the module. To calculate the value of the resistor **R_{trim}** for a particular output voltage **Vo**, use the following equation:

$$R_{trim} = \left[\frac{10500}{V_o - 0.7525} - 1000 \right] \Omega$$

- It's necessary to equip the external input capacitors at the input of the module. The capacitors should connect as close as possible to the input terminals that ensuring module stability. The external C_{in} is 6x47µF ceramic capacitors at least.
- Device code with suffix “-P” – Positive logic(On/Off is open collector/drain logic input; Signal referenced to GND)
Device code with no suffix – Negative logic (On/Off pin is open collector/drain logic input with external pull –up resistor; signal referenced to GND)
- Case 1 :On/Off input is set to logic low (module on) and then input power is applied (delay from instant at which Vin=Vin(min) until Vo=10% of Vo(set))
- Case 2 :Input power is applied for at least one second and then the On/Off input is set to logic low (delay form instant at which Von/off=0.3V until Vo=10% of Vo(set))

CAUTION: This power module is not internally fused. An input line fuse must always be used.

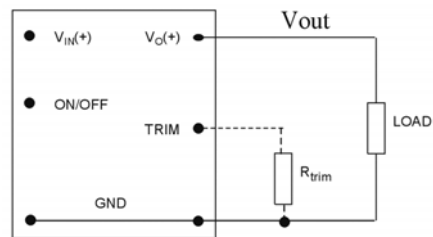
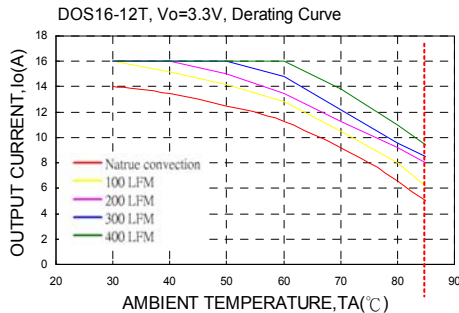
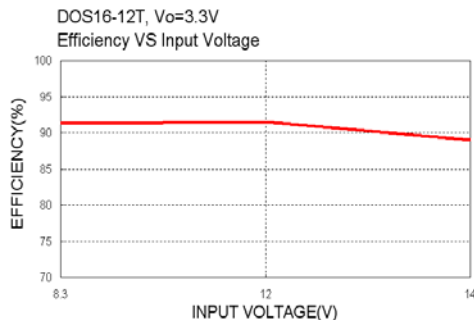
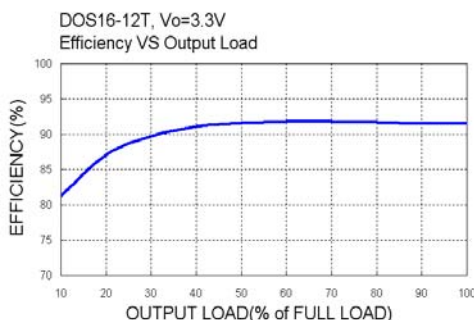


Fig. 1

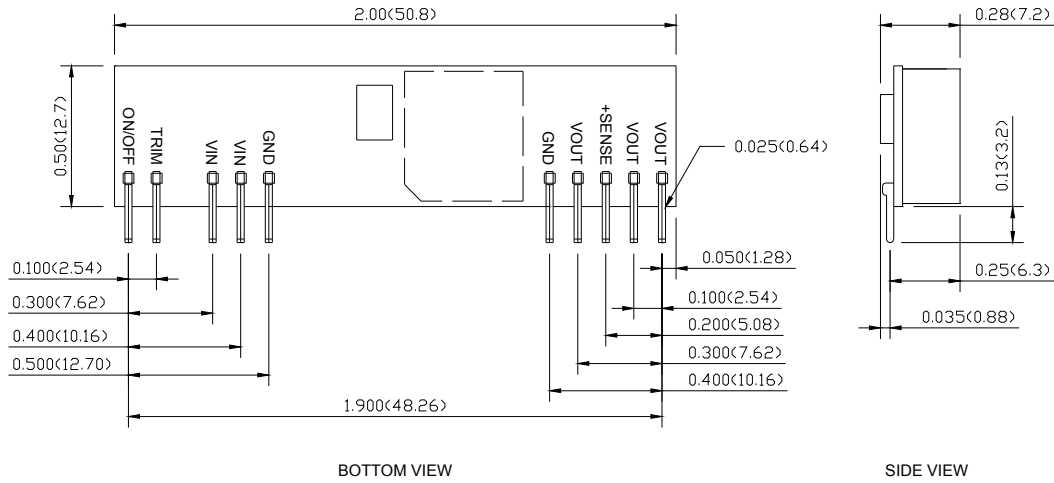


Vo(set) (V)	Rtrim (KΩ)
0.7525	Open
1.2	22.46
1.5	13.05
1.8	9.024
2.5	5.009
3.3	3.122
5	1.472

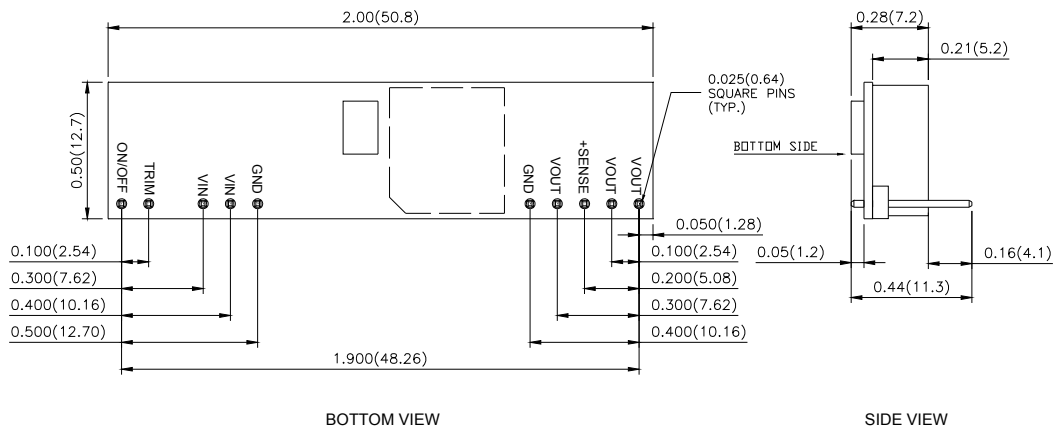




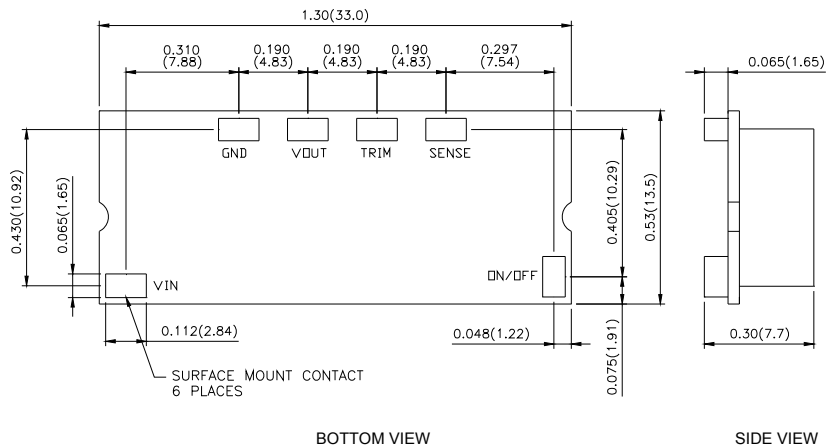
DOH16-12T



DOH16-12TA



DOS16-12T



1. All dimensions in Inches (mm)
Tolerance: X.XX±0.02 (X.X±0.5)
X.XXX±0.01 (X.XX±0.25)
2. Pin pitch tolerance ±0.01 (0.25)
3. Pin dimension tolerance ±0.004 (0.1)